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PATENT NUMBER and
ISSUE DATE

U.S. UTILITY Patent Application

APPL NUM	FILING DATE	CLASS	SUBCLASS	GAU	EXAMINER
10022317	12/18/2001	0521	502	1753	Chen, K

*APPLICANTS: Wojcik William; Baum Thomas; Nguyen Long; Regulski Cary;

*CONTINUING DATA VERIFIED: *MM 5/1/38*
THIS APPLICATION IS A DIV OF 09/562,298 05/01/2000

* FOREIGN APPLICATIONS VERIFIED:

PG-PUB DO NOT PUBLISH <input type="checkbox"/>	RESCIND <input type="checkbox"/>
Foreign priority claimed <input type="checkbox"/> yes <input type="checkbox"/> no	ATTORNEY DOCKET NO
35 USC 119 conditions met <input type="checkbox"/> yes <input type="checkbox"/> no	451-Div
Verified and Acknowledged Examiners's initials	
TITLE: Polishing slurries for copper and associated materials	

U.S. DEPT. OF COM. PAT. & TM. PTO-AEL/REV. 12-94

NOTICE OF ALLOWANCE MAILED		CLAIMS ALLOWED	
		Assistant Examiner	Total Claims Print Claim for O.G.
ISSUE FEE		DRAWING	
Amount Due	Date Paid	Primary Examiner	Sheets Drawn Figs Drawn Print Fig
<input type="checkbox"/> TERMINAL DISCLAIMER		PREPARED FOR ISSUE	Application Examiner
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